

Notice of References Cited

Application No.
09/160,991

Applicant(s)
Cherng et al.

Examiner
Hwei-Siu Payer

Group Art Unit
3724

Page 1 of 2

U.S. PATENT DOCUMENTS

*		DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS
x	A	3,905,283	9-1975	Baker	---	---
x	B	3,952,179	4-1976	Baker	---	---
x	C	4,323,756	4-1982	Brown et al.	---	---
x	D	4,393,738	7-1983	Heyden	---	---
x	E	4,608,895	9-1986	Bell et al.	---	---
x	F	4,927,992	5-1990	Whitelow et al.	---	---
x	G	5,417,132	5-1995	Cox et al.	---	---
x	H	4,383,784	5-1983	Gulbrandsen	76	115
	I					
	J					
	K					
	L					
	M					

FOREIGN PATENT DOCUMENTS

*		DOCUMENT NO.	DATE	COUNTRY	NAME	CLASS	SUBCLASS
x	N	06,297,055	10-1994	Japan	Keizo	76	107.1
x	O	2907325A1	9-1980	Germany	---	---	---
	P						
	Q						
	R						
	S						
	T						

NON-PATENT DOCUMENTS

*		DOCUMENT (Including Author, Title, Source, and Pertinent Pages)	DATE
x	U	Kato Yoshihisa, Manufacture for Tool, 62224527, Patent Abstracts of Japan.	10-1987
x	V	Tanaka Keizo et al., Manufacture of Press Die, 06023448, Patent Abstracts of Japan	2-1994
x	W	Shiraishi Motoatsu et al., Casting Die for Trimming and its Production, 63040621, Patent Abstracts of Japan.	2-1988
x	X	Murphy et al., The rapid Manufacture of Metallic Components by Laser Surface Cladding, pages 803-807.	1994

* A copy of this reference is not being furnished with this Office action.
(See Manual of Patent Examining Procedure, Section 707.05(a).)

Notice of References CitedApplication No.
09/160,991Applicant(s)
Cherng et al.Examiner
Hwei-Siu PayerGroup Art Unit
3724

Page 2 of 2

U.S. PATENT DOCUMENTS

*		DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS
	A					
	B					
	C					
	D					
	E					
	F					
	G					
	H					
	I					
	J					
	K					
	L					
	M					

FOREIGN PATENT DOCUMENTS

*		DOCUMENT NO.	DATE	COUNTRY	NAME	CLASS	SUBCLASS
	N						
	O						
	P						
	Q						
	R						
	S						
	T						

NON-PATENT DOCUMENTS

*		DOCUMENT (Including Author, Title, Source, and Pertinent Pages)	DATE
X	U	Jinbo Takeshi et al., Die, 57058990, Patent Abstracts of Japan.	4-1982
	V		
	W		
	X		

* A copy of this reference is not being furnished with this Office action.
(See Manual of Patent Examining Procedure, Section 707.05(a).)